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Docket No. 742423-6

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Expedited Procedure
Examining Group 2833

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application:) Group: 2833
Kaori Yasufuku et al.) Examiner: F. Figueroa
Application No.: 09/643,948)
Filed: August 23, 2000)
For: CONNECTOR FOR MODULE)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on 10-10-01

[Signature]

AMENDMENT

Commissioner for Patents
Washington, D.C. 20231
ATTN: BOX AF

Sir:

In response to the Official Action of **July 13, 2001**, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend claims 1, 4, 9, 15 and 20 as follows.

Subcl
1. (Twice Amended) A connector for a module that connects the module, the module having a semiconductor chip mounted on a rectangular board and a conductive pad on a front side of the board, to a printed circuit board in a position wherein a plane of the board is substantially parallel to the printed circuit board,

X
said connector comprising:

a connector body having a receiving part that extends along the front side of the module being in a connection position and a groove provided in a rear face thereof into which the front side of the module is inserted, said groove having contacts provided therein which contact the conductive pad on both a top surface and a bottom surface of the module when the module is placed in an

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